TVS Diode Datasheet





Agency Approvals

| Agency | Agency File Number |
|-----------|--------------------|
| 91 | E230531 |

Maximum Ratings and Thermal Characteristics $(T_a=25^{\circ}C \text{ unless otherwise noted})$

| Parameter | Symbol | Value | Unit |
|--|--------------------|------------|------|
| Peak Pulse Power Dissipation at $T_A=25^{\circ}$ C by 10/1000µs Waveform (Fig.2)(Note 1), (Note 2) | P _{PPM} | 4000 | W |
| Power Dissipation on Infinite Heat Sink at $\rm T_{A}{=}50^{\circ}\rm C$ | P _D | 6.5 | W |
| Peak Forward Surge Current, 8.3ms Single Half Sine Wave (Note 3) | I _{FSM} | 300 | A |
| Maximum Instantaneous Forward Voltage at 100A for Unidirectional Only | $V_{\rm F}$ | 3.5 | V |
| Operating Temperature Range | T_J | -65 to 150 | °C |
| Storage Temperature Range | T _{stg} | -65 to 175 | °C |
| Typical Thermal Resistance Junction to Lead | $R_{_{\thetaJL}}$ | 15 | °C/W |
| Typical Thermal Resistance Junction to Ambient | $R_{_{\theta JA}}$ | 75 | °C/W |

Notes:

1. Non-repetitive current pulse , per Fig. 4 and derated above $\rm T_{A}=25^{o}C$ per Fig. 3.

2. Mounted on copper pad area of 0.31x0.31" (8.0 x 8.0mm) to each terminal.

 Measured on 8.3ms single half sine wave or equivalent square wave for unidirectional device only, duty cycle=4 per minute maximum.

Description

The 4.0SMDJ is designed specifically to protect sensitive electronic equipment from voltage transients induced by lightning and other transient voltage events.

Features and Benefits

- For surface mounted applications in order to optimize board space
- Low profile package
- Typical failure mode is short from over-specified voltage or current
- Whisker test is conducted based on JEDEC JESD201A per its table 4a and 4c
- IEC-61000-4-2 ESD 15kV(Air), 8kV (Contact)
- ESD protection of data lines in accordance with IEC 61000-4-2 (IEC801-2)
- EFT protection of data lines in accordance with IEC 61000-4-4 (IEC801-4)
- Built-in strain relief
- Glass passivated chip junction

- 4000W peak pulse power capability at 10/1000µs waveform, repetition rate (duty cycles):0.01%
- Fast response time: typically less than 1.0ps from 0V to BV min
- Excellent clamping capability
- Low incremental surge resistance
- Meet MSL level 1 per J-STD-020, and high temperature soldering guaranteed: 260°C/10sec
- Matte tin lead–free plated
- Halogen free and RoHS compliant
- Plastic package is flammability rated V-0 per UL 94

Applications

TVS devices are ideal for the protection of I/O Interfaces, V_{cc} bus and other vulnerable circuits used in Telecom, Computer, Industrial and Consumer electronic applications.

Functional Diagram

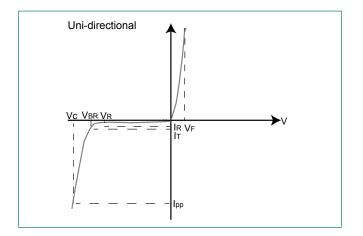


| Liectrical characteristics (1 _A =23 C drifess otherwise noted) | | | | | | | | | | | | |
|---|---------|---|-------|-------|----------------------|------|---|----------|---|--|---|--------------------|
| Part Number Marki | Marking | Reverse Stand off Voltage V _R (Volts) | | | Current | @ | Maximum Clamping Voltage V _c @ I _{pp} (8/20µS) (V) | Currenti | Maximum Peak Pulse Current I _{pp} (8/20µS) (A) | Maximum Reverse Leakage I _R @ V _R (μΑ) | Maximum Temperature Coefficient of V _{BR} (%/C) | Agency Approval |
| | | | MIN | МАХ | (mA) (10/1000µS) (V) | | | | | | | |
| 4.0SMDJ10A | 4PDX | 10.0 | 11.10 | 12.30 | 1 | 17.0 | 29.0 | 235.5 | 1480.0 | 5 | 0.071 | х |
| 4.0SMDJ11A | 4PDZ | 11.0 | 12.20 | 13.50 | 1 | 18.2 | 31.0 | 220.0 | 1385.0 | 2 | 0.074 | х |
| 4.0SMDJ12A | 4PEE | 12.0 | 13.30 | 14.70 | 1 | 19.9 | 32.0 | 201.5 | 1270.0 | 2 | 0.075 | х |
| 4.0SMDJ13A | 4PEG | 13.0 | 14.40 | 15.90 | 1 | 21.5 | 34.0 | 186.5 | 1175.0 | 2 | 0.076 | х |
| 4.0SMDJ14A | 4PEK | 14.0 | 15.60 | 17.20 | 1 | 23.2 | 35.0 | 172.5 | 1085.0 | 2 | 0.080 | х |
| 4.0SMDJ15A | 4PEM | 15.0 | 16.70 | 18.50 | 1 | 24.4 | 37.0 | 164.0 | 1033.0 | 2 | 0.083 | х |
| 4.0SMDJ18A | 4PET | 18.0 | 20.00 | 22.10 | 1 | 29.2 | 42.0 | 137.0 | 860.0 | 2 | 0.088 | х |
| 4.0SMDJ20A | 4PEV | 20.0 | 22.20 | 24.50 | 1 | 32.4 | 45.0 | 123.5 | 780.0 | 2 | 0.091 | х |
| 4.0SMDJ24A | 4PEZ | 24.0 | 26.70 | 29.50 | 1 | 38.9 | 51.0 | 103.0 | 650.0 | 2 | 0.092 | х |

Electrical Characteristics (T_a=25°C unless otherwise noted)

 $V_{BR} @T_{J} = V_{BR} @25^{\circ}C \times (1 + \alpha T \times (T_{J} - 25)) (\alpha T:Temperature Coefficient)$

I-V Curve Characteristics



- **P**_{PPM} **Peak Pulse Power Dissipation** Max power dissipation
- V₈ Stand-off Voltage -- Maximum voltage that can be applied to the TVS without operation
- V_{BR} Breakdown Voltage -- Maximum voltage that flows though the TVS at a specified test current (I₁)
- V. Clamping Voltage -- Peak voltage measured across the suppressor at a specified lppm (peak impulse current)
- $I_{_{\!R}}$ Reverse Leakage Current -- Current measured at V_{_{\tiny R}</sub>
- V, Forward Voltage Drop for Uni-directional



Ratings and Characteristic Curves ($T_A = 25^{\circ}C$ unless otherwise noted)

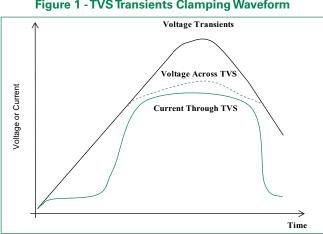


Figure 1 - TVS Transients Clamping Waveform

Figure 3 - Peak Pulse Power Derating Curve

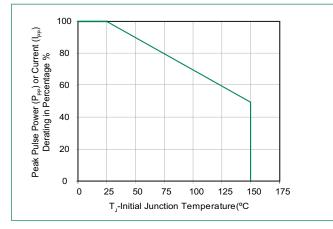


Figure 5 - Typical Transient Thermal Impedance

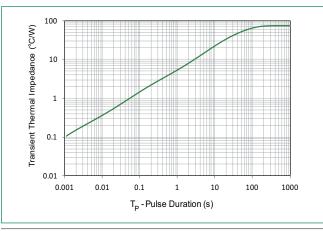


Figure 2 - Peak Pulse Power Rating

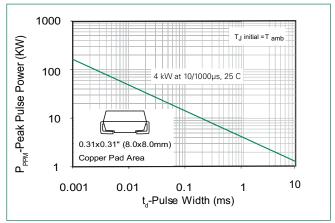


Figure 4 - Pulse Waveform

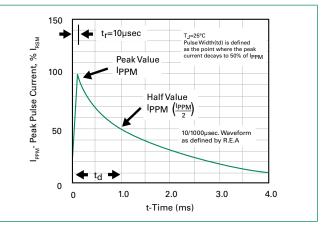
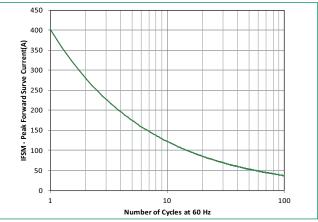


Figure 6 - Maximum Non-Repetitive Peak Forward Surge **Current Uni-Directional Only**



Ratings and Characteristic Curves (T_A =25°C unless otherwise noted)

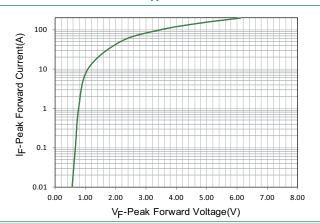


Figure 7 - Peak Forward Voltage Drop vs Peak Forward Current (Typical Values)

Soldering Parameters

| Reflow Cond | lition | Lead–free assembly | |
|---|---|-------------------------|--|
| Pre Heat | - Temperature Min (T _{s(min)}) | 150°C | |
| | - Temperature Max (T _{s(max)}) | 200°C | |
| | -Time (min to max) (t _s) | 60 – 120 secs | |
| Average ram peak | p up rate (Liquidus Temp (T _L) to | 3°C/second max | |
| $\mathbf{T}_{_{\mathbf{S}(\mathrm{max})}}\mathbf{to}\mathbf{T}_{_{\mathbf{L}}}$ - | Ramp-up Rate | 3°C/second max | |
| Reflow | - Temperature (T _L) (Liquidus) | 217°C | |
| nenow | -Time (min to max) (t _s) | 60 – 150 seconds | |
| Peak Temper | ature (T _p) | 260 ^{+0/-5} °C | |
| Time within (t _p) | 5°C of actual peak Temperature | 30 seconds | |
| Ramp-down | Rate | 6°C/second max | |
| Time 25°C to | o peak Temperature (T _P) | 8 minutes Max. | |
| Do not excee | ed | 260°C | |

Tp-TL Ts(max) Ts(max)

t,→

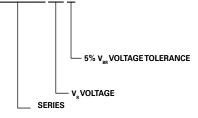
Environmental Specifications

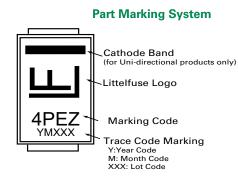
| High Temp. Storage | JESD22-A103 |
|---------------------|--------------------------|
| HTRB | JESD22-A108 |
| Temperature Cycling | JESD22-A104 |
| MSL | JEDEC-J-STD-020, Level 1 |
| H3TRB | JESD22-A101 |
| RSH | JESD22-A111 |

Physical Specifications

| Weight | 0.007 ounce, 0.21 grams |
|----------|---|
| Case | JEDEC DO214AB. Molded plastic body over glass passivated junction |
| Polarity | Color band denotes positive end (cathode) except Bidirectional. |
| Terminal | Matte Tin-plated leads, Solderable per JESD22-B102 |

Part Numbering System 4.0SMDJ ^{XX} A

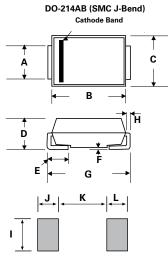




Packaging Options

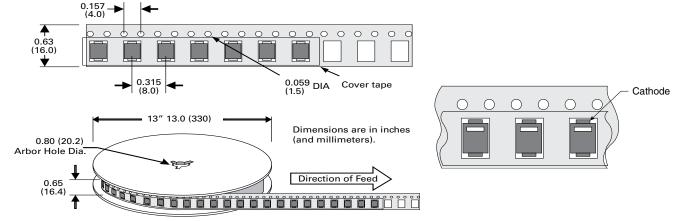
| Part number | Component Package | Quantity | Packaging Option | Packaging Specification |
|-------------|-------------------|----------|----------------------------------|-------------------------|
| 4.0SMDJxxA | DO-214AB | 3000 | Tape & Reel - 16mm tape/13" reel | EIA STD RS-481 |

Dimensions



| Dimensions | Inc | hes | Millimeters | | |
|------------|-------|-------|-------------|-------|--|
| Dimensions | Min | Мах | Min | Max | |
| А | 0.114 | 0.126 | 2.900 | 3.200 | |
| В | 0.260 | 0.280 | 6.600 | 7.110 | |
| С | 0.220 | 0.245 | 5.590 | 6.220 | |
| D | 0.079 | 0.103 | 2.060 | 2.620 | |
| E | 0.030 | 0.060 | 0.760 | 1.520 | |
| F | - | 0.008 | - | 0.203 | |
| G | 0.305 | 0.320 | 7.750 | 8.130 | |
| Н | 0.006 | 0.012 | 0.152 | 0.305 | |
| I | 0.129 | - | 3.300 | - | |
| J | 0.094 | - | 2.400 | - | |
| К | - | 0.165 | | 4.200 | |
| L | 0.094 | - | 2.400 | - | |

Tape and Reel Specification



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